

# EM358x Reference Design With 0805 Ceramic Balun Front End, USB, Inverted F PCB Antenna, 4-Layer

Sheet	Description
1.	Cover Page
2.	Block Diagrams
3.	EM358x/Balun
4.	Appendixes
5.	Revision & Design Notes

This design is intended for use as a reference for custom designs utilizing EM358x ZigBee radios which include the USB option and EM35xx ZigBee radios which do not. Some of the connections shown in this design are different from other Silicon Labs EM35xx ZigBee reference designs which do not include USB. If you are unsure about use of the USB option or if you know your design will not require USB, please contact your region’s Silicon Labs Sales Office for assistance with choosing the appropriate EM35xx ZigBee products, features and the corresponding reference design.

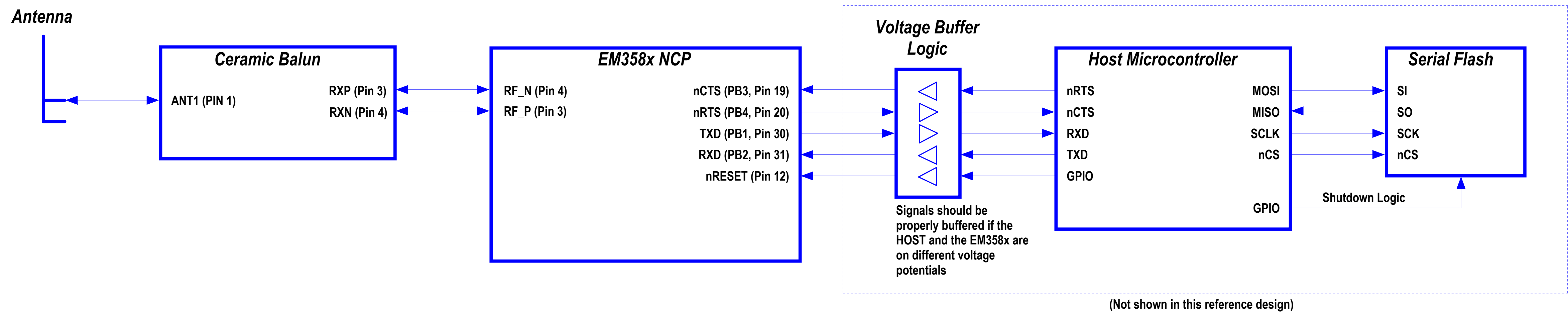
Click on the following links below for additional information regarding EM35xx ZigBee products and for the location of the nearest Silicon Labs Sales office;

[EM35xx ZigBee Product Information](#)

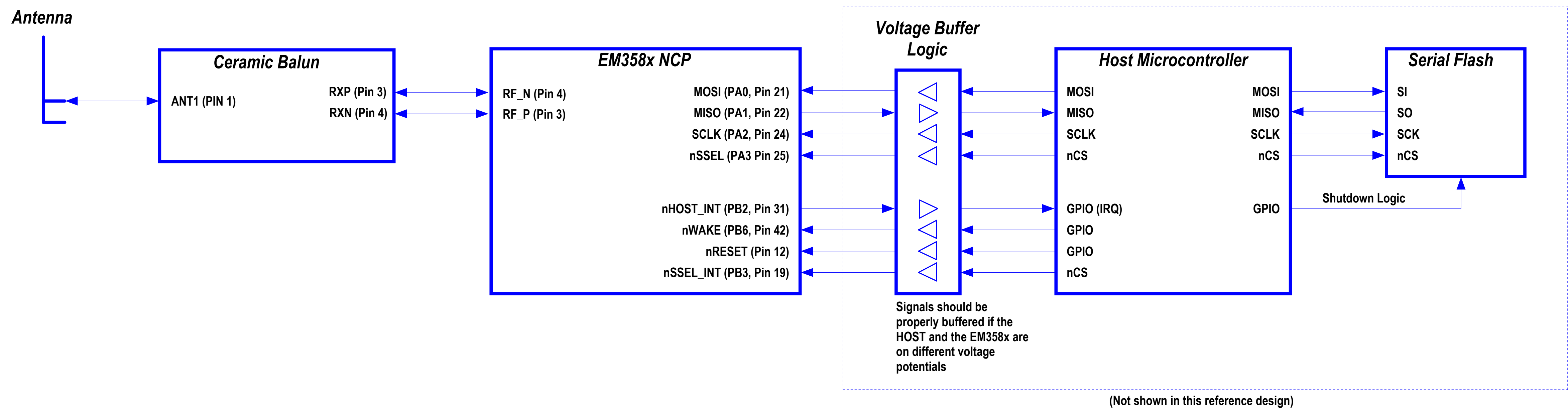
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The schematics in this package can be used in both NCP & SOC designs involving the EM358x. Connect NCP to the HOST using either UART or SPI serial connection as shown below.

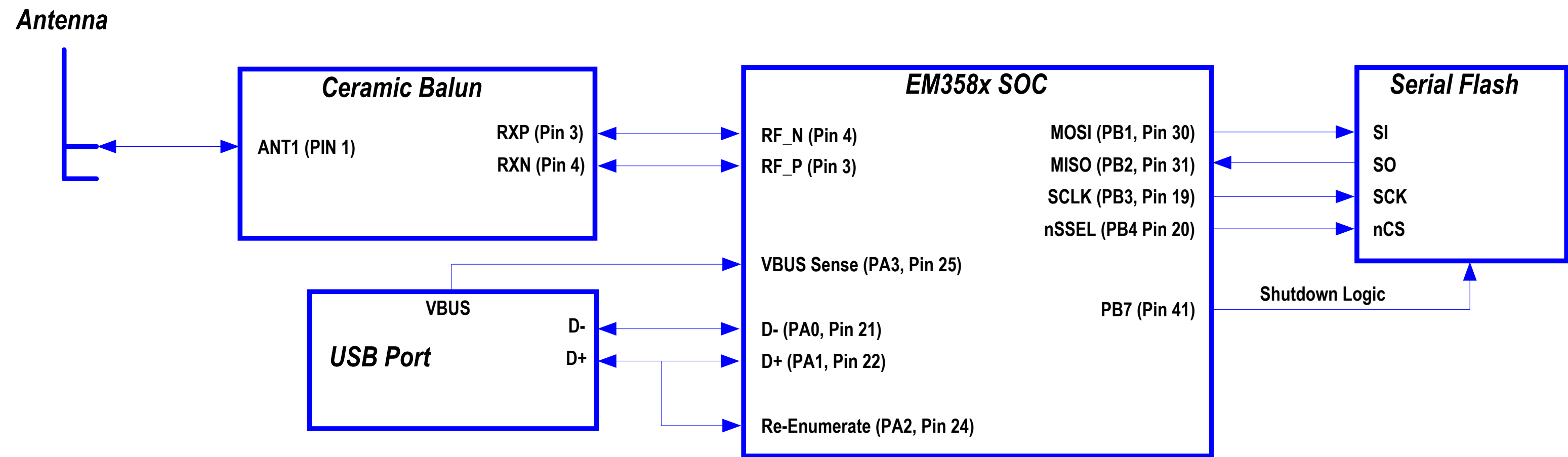
EM358x NCP with EZSP over Asynchronous Serial (UART)



EM358x NCP with EZSP over Synchronous Serial (SPI)

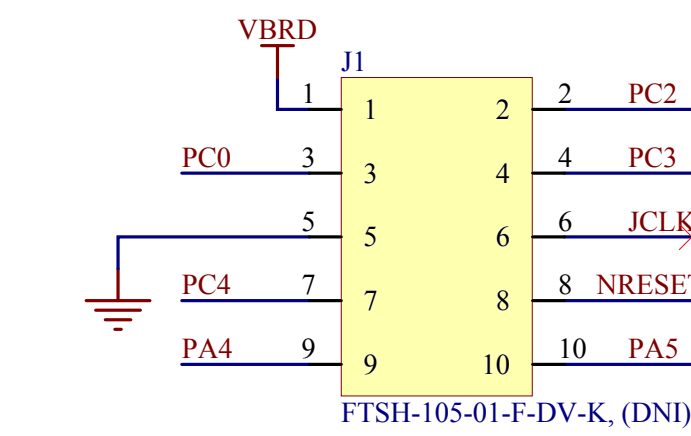


EM358x SOC Reference Design, (USB Option Shown)



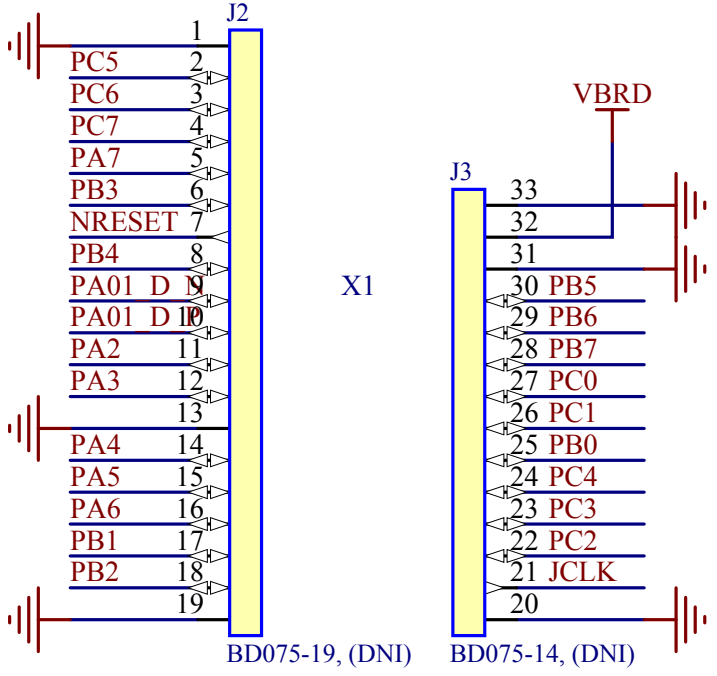
### Packet Trace Port (Optional)

The J1 Packet Trace Port interface footprint, sized for a 10 pin dual row 0.05" pitch connector compatible with a Samtec FFSD series ribbon cable, (FFSD-05-D-12.00-01N), is required to make use of Ember Desktop software tools by enabling a direct connection to an Ember Debug Adapter (ISA3). This part can be optionally made 'Do Not Install' in production.



### Board to Board Interface (Optional)

The X1 interface is not required for customer designs and is a surface mount 0.05" pitch header arrangement designed to be compatible with the EM358x Series Development Kit Breakout Boards. J2 and J3 can be optionally made 'Do Not Install', or replaced with a different board to board interface arrangement, or removed entirely to facilitate a merger into an already existing PCB layout design.



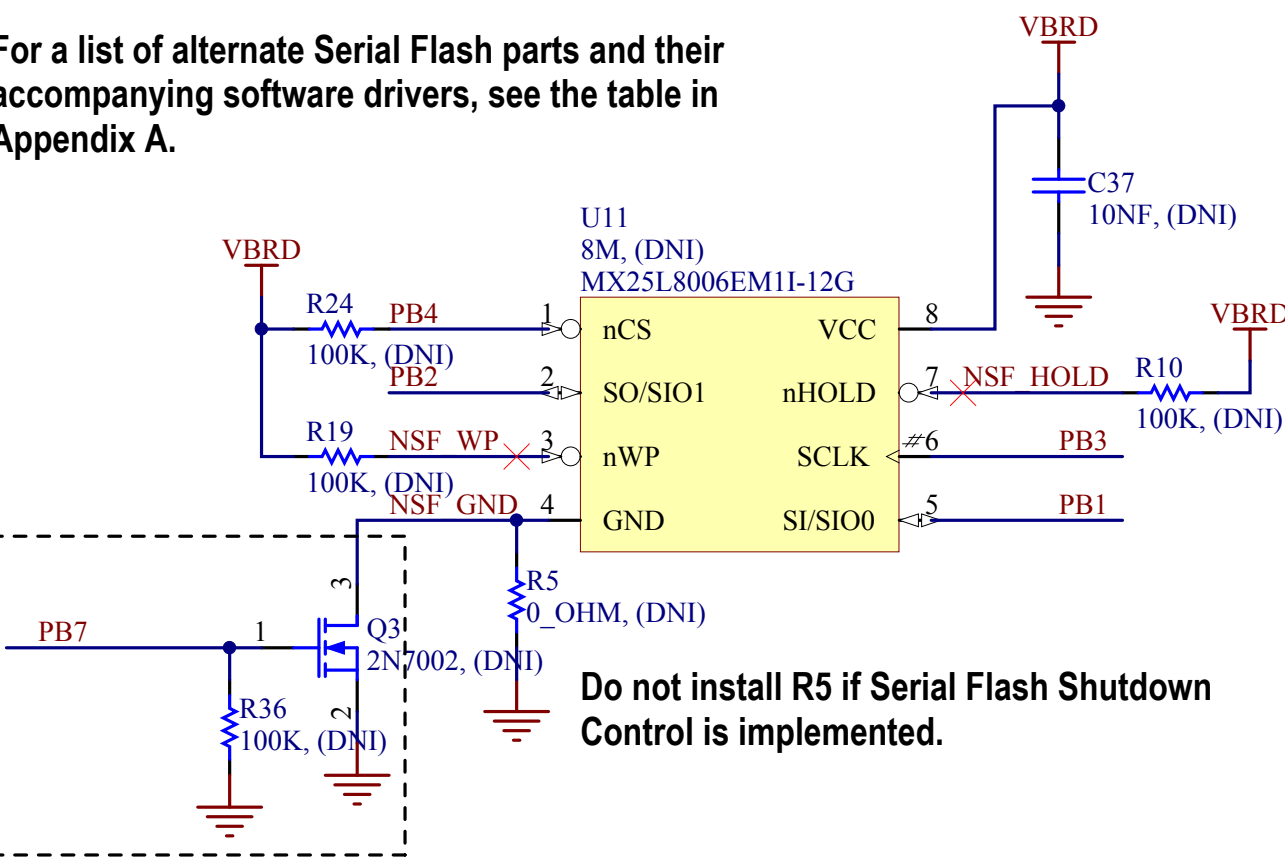
### Serial Flash (Optional)

Serial Flash is required for Over The Air (OTA) Bootloader support as mandated by some applications of the ZigBee profiles but can be optionally made 'Do Not Install' for any end use application not requiring OTA Bootloader support.

For maximum power efficiency in custom application code, include firmware instructions to sleep the Serial Flash and any other peripherals prior to placing the EM358x in shutdown mode.

For applications utilizing the EM358x USB feature, connect the Serial Flash to Serial Controller 1, (SC1), as shown below. In applications where the USB feature is not utilized, the Serial Flash can be connected to Serial Controller 2, (SC2).

For a list of alternate Serial Flash parts and their accompanying software drivers, see the table in Appendix A.



### Serial Flash Shutdown Control (Optional)

The EM358x SOC reference design uses PB7 to enable or disable Q3 for the purpose of controlling current consumed by the Serial Flash when not in use, however, any GPIO can be utilized for this purpose. Q3 and R36 can be optionally made "Do Not Install" if overall power efficiency is not a requirement.

Shutdown signaling for the Serial Flash, FEM, and other peripherals can be tied to a single GPIO for applications not requiring a separate control signal for each.

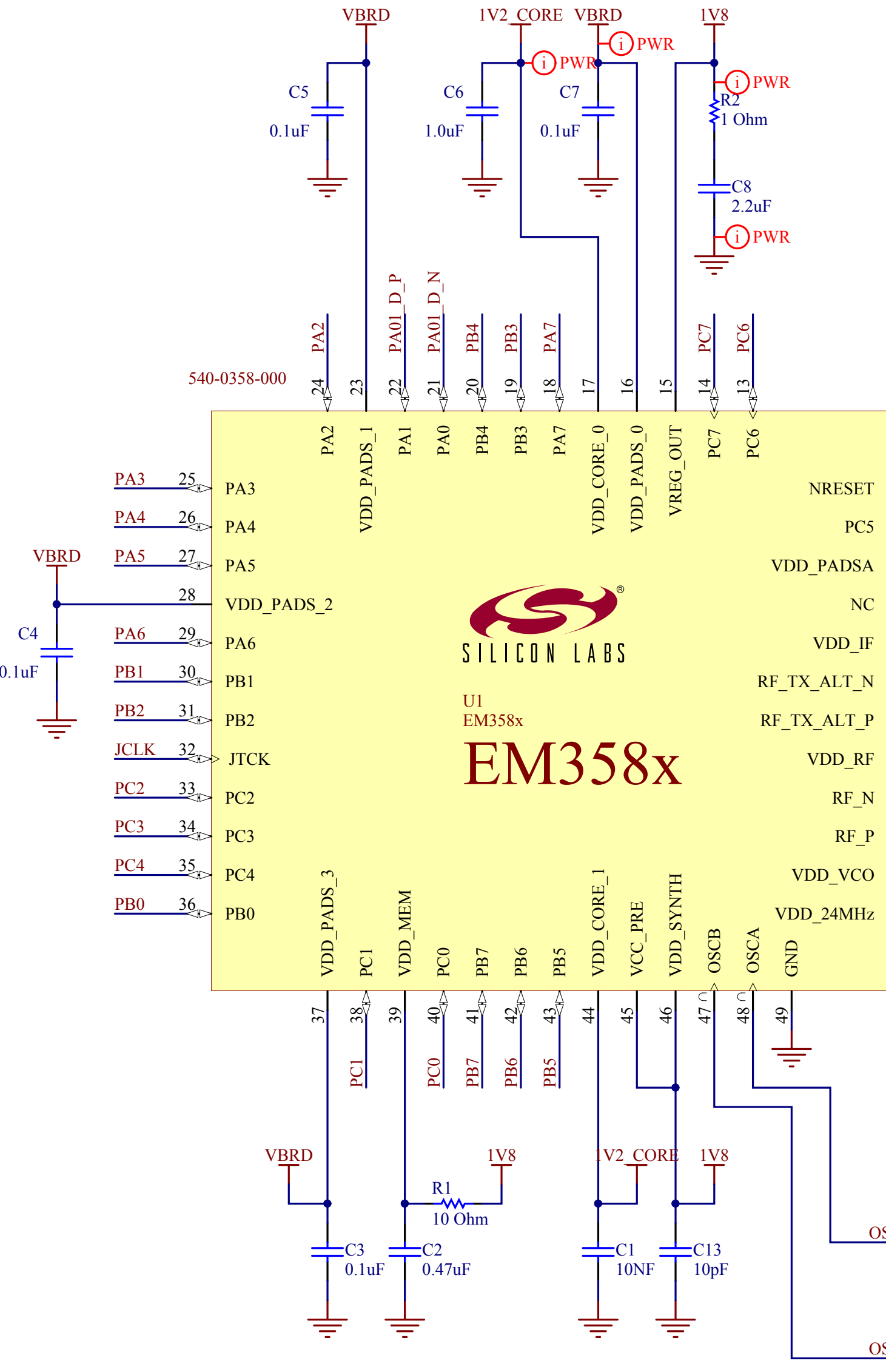
A custom OTA Application Bootloader file with the command line EEPROM\_USES\_SHUTDOWN\_CONTROL defined in the header file, is required for designs using the Serial Flash shutdown control.

### EM358x Zigbee SOC

High-Performance, Integrated ZigBee/802.15.4 System-on-Chip Solution with an internal 32-bit ARM CORTEX-M3 core processor with up to 64K of internal RAM and up to 512K of internal FLASH and AES128 encryption accelerator in a 7 x 7 mm QFN-48 package.

### 1V25\_CORE Component Note

A ceramic capacitor with a minimum value of 1uF between pin 17 and ground is required for cost effective 1V25\_CORE voltage regulator output stability.



## Appendix A: Approved Serial Flash Providers for the EM358x/0805 Ceramic Balun Front End 4-Layer Reference Design

The table below provides details for Serial Flash devices intended for this Reference Design. For a complete list of Serial Dataflash devices supported by the Silicon Labs ZigBee software stack, refer to the Table 2. Supported Serial Dataflash/EEPROM Remote Memory Parts, in Application Note AN772, Using Application Bootloader.

Table 1: Silicon Labs Zigbee Serial Flash Vendor Parts List

Manufacturer	Part Number	Description	Software Driver
WinBond	W25X20BVSNIG	2M (256K x 8)	spiflash-class1.c
WinBond	W25Q80BVSNIG	8M (256K x 32)	spiflash-class1.c
Macronix	MX25L2006EM1I-12G	2M (2M x 1, 1M x 2)	spiflash-class1.c
Macronix	MX25L8006EM1I-12G	8M (8M x 1, 4M x 2)	spiflash-class1.c

## Appendix B: Suggested 24MHz Crystal Providers for the EM358x/0805 Ceramic Balun Front End 4-Layer Reference Design

The tables below provide details for 24MHz crystal devices which can be used with EM358x series ZigBee products for the manufacture of ZigBee radio devices. Check with your preferred crystal vendor for the latest updates on their product offering or for additional information about crystals for the EM358x ZigBee products in your target application.

Table 2: Suggested 24MHz ZigBee Crystal Vendor Parts List for Crystal Packages Used in this design

Manufacturer	Part Number	Package Size	Frequency Tol	Temperature Stability	Aging	Total Frequency Tol	ESR	Load Capacitance	Tuning Capacitor
Abracon	ABLS-24.000MHZ-D1X-T	HC/49US (AT49)	+/- 10 ppm	+/- 20ppm (-40 +85)	+/- 10 ppm/5 years		40 ohms		
Abracon	ABLS-24.000MHZ-D-R60-1-W-T	HC/49US (AT49)	+/- 10 ppm	+/- 15ppm (-40 +85)	+/- 5 ppm/year		60 ohms	18pF	22pF
Abracon	ABLS-438-24.000MHZ-T	HC/49US (AT49)	+/- 10 ppm	+/- 15ppm (-40 +85)	+/- 15 ppm/20 years		40 ohms	18pF	22pF
ILSI	HC49USM-24.000000M-2435	HC49US	+/- 10 ppm	(-40 +85)			30 ohms	18pF	
AEL	X24M000000S067	HC49S SM	+/- 10 ppm @25C	+/- 25ppm (-40 +105)	+/- 3 ppm/year max		80 ohms	10pF	

Table 3: Suggested 24MHz ZigBee Crystal Vendor Parts List for High Temperature Rated Crystals Having Alternate Package/PCB Dimensions than is Used in this Design

Manufacturer	Part Number	Package Size	Frequency Tol	Temperature Stability	Aging	Total Frequency Tol	ESR	Load Capacitance	Tuning Capacitor
Abracon	ABM8X-101-24.000MHZ	3.2 x 2.5 x 0.7mm	+/- 10 ppm	+/- 25 ppm (-40 +125)	+/- 5 ppm/10 years	+/- 40 ppm (-40 +125)/10 years max	60 ohms	10pF	6.8pF
Abracon	ABM3Y-101-24.000MHZ-T	5.0 X 3.2 X 0.9mm	+/- 10 ppm	+/- 25 ppm (-40 +105)	+/- 10 ppm/5 years		30 ohms	10pF	
AEL	X24M000000S037	3.2 x 2.5 x 0.6mm	+/- 10 ppm @25C	+/- 25 ppm (-40 +105)	+/- 3 ppm/year max		80 ohms	10pF	
EPSON	TSX-3225 24.0000MF20G-C	3.2 x 2.5 x 0.6mm	+/- 10 ppm	+/- 20 ppm (-40 +105)	+/- 1 ppm/First year Max @ +25		60 ohms	18pF	
ILSI	ILCX07-24.000000M-2390	5.0 X 3.2 X 1.30mm		(-40 +105)			60 ohms	18pF	
ILSI	ILCX07-24.000000M-2392	3.2 x 2.5 x 0.9mm		(-40 +105)			60 ohms	18pF	

Table 4: Suggested 24MHz ZigBee Crystal Vendor Parts List for Commercial and Industrial Rated Crystals Having Alternate Package/PCB Dimensions than is Used in this Design

Manufacturer	Part Number	Package Size	Frequency Tol	Temperature Stability	Aging	Total Frequency Tol	ESR	Load Capacitance	Tuning Capacitor
Abracon	ABM8-24.000MHZ-R60-D-1-W-T	3.2 x 2.5 x 0.7mm	+/- 10 ppm	+/- 25 ppm (-40 +85)	+/- 3 ppm/First year max @ +25		60 ohms	18pF	22pF
Abracon	ABM8-24.000MHZ-R60-D-1-G-T	3.2 x 2.5 x 0.7mm	+/- 10 ppm	+/- 15 ppm (-40 +85)	+/- 3 ppm/First year max @ +25		60 ohms	18pF	22pF
Abracon	ABM8-177-24.000mHz	3.2 x 2.5 x 0.7mm	+/- 10 ppm	+/- 15 ppm (-40 +85)	+/- 15 ppm/20 years		60 ohms	18pF	22pF
AEL	X24M000000S050	3.2 x 2.5 x 0.6mm	+/- 10 ppm @25C	+/- 25 ppm (-40 +85)	+/- 3 ppm/year max		60 ohms	10pF	8.2pF
AEL	X24M000000S058	3.2 x 2.5 x 0.6mm	+/- 10 ppm @25C	+/- 15 ppm (-40 +85)	+/- 15 ppm/20 years max		60 ohms	10pF	
EPSON	TSX-3225 24.0000MF18X-C 18pF	3.2 x 2.5 x 0.7mm	+/- 10 ppm	+/- 18 ppm	+/- 1 ppm/First year max @ +25		60 ohms	18pF	27pF
ILSI	ILCX13-24.000000M-2391	3.2 x 2.5 x 0.6mm		(-40 +85)			60 ohms	18pF	
ILSI	ILCX07-24.000000M-2389	5.0 X 3.2 X 1.30mm		(-40 +85)			60 ohms	18pF	
KDS	1ZCA24000ZZ0C	2.5 x 2.0 x 0.75mm				+/- 40 ppm (-40 +105)/10 years max	80 ohms	18pF	
KDS	1ZC224000ZZ0G	3.2 x 2.5 x 0.75mm				+/- 40 ppm (-40 +105)/10 years max	60 ohms	18pF	
KDS	1C324000ZZ0D	3.2 x 2.5 x 0.75mm				+/- 40 ppm (-40 +105)/10 years max	60 ohms	18pF	
KDS	1ZCB24000ZZ0B	2.5 x 2.0 x 0.75mm				+/- 40 ppm (-40 +105)/10 years max	60 ohms	18pF	
Precision Devices, Inc.	C324000XFAD13RX	3.2 x 2.5 x 0.7mm	+/- 10 ppm	+/- 20 ppm (-40 +70)	+/- 5 ppm/over life of the part		60 ohms	13pF	15pF
Partron America Corp	CX5X24000FHVRG01	3.2 x 2.5 x 0.75mm	+/- 10 ppm	+/- 15 ppm (-40 +85)	+/- 2 ppm/ year @ +25		60 ohms	18pF	27pF
Suntsu	SCM18D48-24.000MHZ	3.2 x 2.5 x 0.65mm	+/- 10 ppm	+/- 15 ppm (-40 +85)	+/- 2 ppm/1st Year max, then +/- 1ppm/year		80 ohms	18pF	22pF
TXC Technology	7B-24.000MEEQ-T	5.0 X 3.2 X 1.30mm	+/- 10 ppm	+/- 10 ppm (-40 +85)	+/- 3 ppm/year max		40 ohms	18pF	
TXC Technology	7M-24.000MEEQ-T	3.2 x 2.5 x 0.7mm	+/- 10 ppm	+/- 10 ppm (-40 +85)	+/- 3 ppm/year max		60 ohms	18pF	

